

DW9249 - SAW Bandpass Filter for DECT

Supersedes March 1997 version, DS4548 - 2.3

# Application Note

AN3833 - 1.2 July 1993

AN3833

#### **SELECTION OF IF FREQUENCY:**

The DW9249 is a S.A.W. Bandpass Filter designed specifically for use in Digital European Cordless Telephones (D.E.C.T.). A circuit schematic of a typical DECT receiver architecture is shown in Fig. 1. In this design a superhet philosophy is employed, using an Intermediate frequency (I.F.) at typically 110 to 112 MHz. Early designs of DECT receivers used 110.592 MHz but more recently this has been avoided owing to 6th or 8th harmonic leak through from either an 18.432MHz or 13.824 MHz reference oscillator. For this reason 112.32 MHz has now become a preferred standard.

### **DECT DESIGN CONSIDERATIONS:**

The DW9249 operates at 112.32MHz and has an minimum operating 3dB bandwidth of 1200 KHz. The modulation rate and type specified within DECT demand an operating bandwidth of ±576 KHz under all conditions. Furthermore the DECT standard specifies a co-channel performance of 10dB and 15dB adjacent channel interference performance. These two requirements should be met allowing for all manufacturing, ageing and temperature tolerances. Overall allowance for these parameters, translates into a tight specification on the filter roll-off (shaping) characteristics.

An operating temperature range of -20°C to +85°C is recommended with a minimum requirement of 0°C to +40°C. It is for this reason that ST Quartz is used by Mitel Semiconductor as the substrate medium. Lithium Niobate based devices have extremely poor temperature performance with Lithium Tantalate being only marginally better. If the latter of these materials were to be employed then operational performance could only be guaranteed over the restricted temperature of 0°C to 40°C. For this reason Lithium Tantalate based devices have been primarily restricted to use in Test Systems enjoying a controlled climatic environment. On the other hand, the advantages from the use of Quartz as a substrate medium substantially improves the device manufacturability and co-channel/adjacent channel interference performance.

#### SAW FILTER DESIGN OPTIONS:

The next issue in the choice of design of Filter for DECT filtering has been the trade-offs between the demands for low Insertion Loss and low Group Delay ripple. Unlike many pure analogue communications systems, particular attention must be paid in digital communications to the phase or group delay ripple parameters of components. Phase distortion will

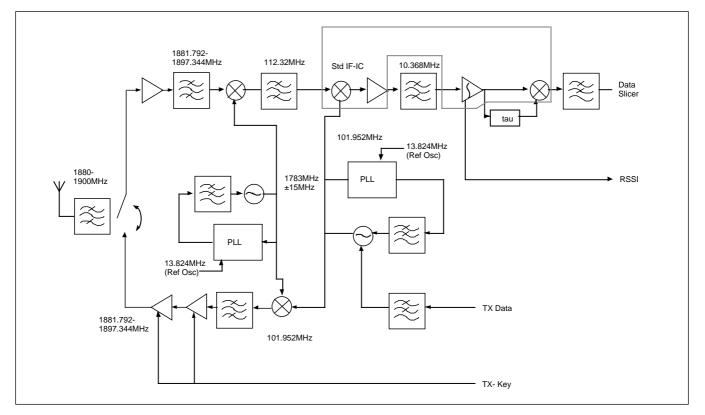


Figure 1: Block Diagram of a Typical 2GHz Radio

# **DW9249 Application Note**

contribute directly to system Bit Error Rate (BER). Most DECT system designers have settled on an upper limit of allocation to the SAW filter group delay ripple at 300nS.

The choice is all the more complicated by the fact that SAW fillers can be realised in fundamentally one of two different ways: as Resonator filters or as Transversal filters. A comparison of the relative performance of SAW resonator and transversal filters is given in Table 1.

In brief, SAW Resonators can provide DECT system designs with low insertion loss filters hence reducing the gain and associated current consumption. This is achieved however at considerable expense overall on the system performance and manufacturability. Group delay ripple for a DECT based design resonator filter is typically five to ten times higher than that for a typical transversal filter at ambient. This figure can degrade further under full operating temperature conditions and time; matching impedances are highly sensitive; impedance matching networks are complicated by the need commonly to interface into an unbalanced mixer; cochannel rejection can be marginal against specification over the operating temperature range. Saw bi-directional transversal filters on the other hand have an insertion loss of typically 14-16dB, and may require additional gain. However the filter has many compensating features including:

- 1. Excellent co-channel characteristics
- 2. Time and temperature stable matching impedances permitting simple, single element, fixed value matching components
- 3. Option for balanced or unbalanced drive networks
- 4. Exceptionally low group delay ripple
- 5. Operation over either the full or extended DECT temperature range
- 6. Good third order intercept point

In conclusion, Mitel Semiconductor recommend the adoption of a ST cut Quartz Transversal filter - DW9249 for use as an 112.32MHz IF filter in DECT receivers.

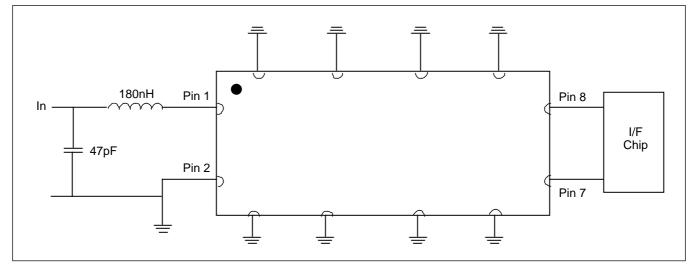
	ADVANTAGES	DISADVANTAGES
TRANSVERSAL FILTER DESIGN	V.Low Group Delay Ripple Stable Matching Impedances Balanced/Unbalanced Drive Good Stopband Rejection	Increased Insertion Losses Restricted Minimum Fraction Bandwidth >0.3% Increased Size
RESONATOR FILTER DESIGN	V.Low Insertion Loss V.Narrow Fractional Bandwidths Good Co-Channel Selectivity	V.Poor Group Delay Ripple Unbalanced Drive Option Only
		Mediocre Stop Band Rejection

Table 1: SAW Filter Technology Comparison

## **CIRCUIT MATCHING NETWORK:**

Significantly, the SAW filter is designed asymmetric with the input and output impedances configured independently. Furthermore, the SAW frequency response is purposefully designed to have an asymmetric amplitude characteristic when measured unmatched in 50 ohms, but a symmetric amplitude when appropriately matched into the correct impedances. Two options for matching configurations are presented here:

1. Input: 50 ohms / Unbalanced drive Output: High Impedance IF Downconversion chip / Balanced drive





2. Input: 50 ohms / Unbalanced Output: 50 ohms / Unbalanced drive

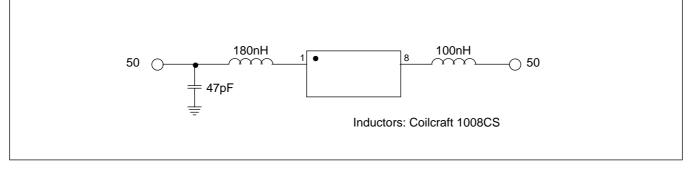


Figure 3



### HEADQUARTERS OPERATIONS

MITEL SEMICONDUCTOR Cheney Manor, Swindon, Wiltshire SN2 2QW, United Kingdom. Tel: (01793) 518000 Fax: (01793) 518411

MITEL SEMICONDUCTOR 1500 Green Hills Road,

Scotts Valley, California 95066-4922 United States of America. Tel (408) 438 2900 Fax: (408) 438 5576/6231

## Internet: http://www.gpsemi.com

- CUSTOMER SERVICE CENTRES
- FRANCE & BENELUX Les Ulis Cedex Tel: (1) 69 18 90 00 Fax : (1) 64 46 06 07
- GERMANY Munich Tel: (089) 419508-20 Fax : (089) 419508-55
- ITALY Milan Tel: (02) 6607151 Fax: (02) 66040993
- JAPAN Tokyo Tel: (03) 5276-5501 Fax: (03) 5276-5510
- .
- KOREA Seoul Tel: (2) 5668141 Fax: (2) 5697933 .
- NORTH AMERICA Scotts Valley, USA Tel: (408) 438 2900 Fax: (408) 438 5576/6231 •
- SOUTH EAST ASIA Singapore Tel:(65) 3827708 Fax: (65) 3828872
- SWEDEN Stockholm Tel: 46 8 702 97 70 Fax: 46 8 640 47 36 •
- TAIWAN, ROC Taipei Tel: 886 2 25461260 Fax: 886 2 27190260 •
- UK, EIRE, DENMARK, FINLAND & NORWAY •
- Swindon Tel: (01793) 726666 Fax : (01793) 518582 These are supported by Agents and Distributors in major countries world-wide. © Mitel Corporation 1998 Publication No. AN3833 Issue No. 1.2 July 1993 TECHNICAL DOCUMENTATION - NOT FOR RESALE. PRINTED IN UNITED KINGDOM

This publication is issued to provide information only which (unless agreed by the Company in writing) may not be used, applied or reproduced for any purpose nor form part of any order or contract nor to be regarded as a representation relating to the products or services concerned. No warranty or guarantee express or implied is made regarding the capability, performance or suitability of any product or service. The Company reserves the right to alter without prior notice the specification, design or price of any product or service. Information concerning possible methods of use is provided as a guide only and does not constitute any guarantee that such methods of use will be satisfactory in a specific piece of equipment. It is the user's responsibility to fully determine the performance and suitability of any equipment using such information and to ensure that any publication or data used is up to date and has not been superseded. These products are not suitable for use in any medical products whose failure to perform may result in significant injury. or death to the user. All products and materials are sold and services provided subject to the Company's conditions of sale, which are available on request.

All brand names and product names used in this publication are trademarks, registered trademarks or trade names of their respective owners